

3.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Product Summary (@TA = +25°C)

V _{RRM} (V)	lo (A)	V _F (V)	I _R (μA)	t _{RR} (ns)
600	3	1.25	5	50

Features and Benefits

- Glass Passivated Die Construction
- Super-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 100A Peak
- Ideally Suited for Automated Assembly
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Description and Applications

The super-fast recovery time of the MURS360B makes it suitable for boost diode in discontinuous or critical mode power factor corrections. The device is also intended for use as a free-wheeling diode in power supplies and other power switching applications.

Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208@3
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.1046 grams (Approximate)

SMB





Ordering Information (Note 4)

Ī	Part Number	Compliance	Case	Packaging
	MURS360B-13-F	Commercial	SMB	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



U3JB = Product Type Marking Code) | | = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 0 for 2020) WW = Week Code (01 to 52)



Maximum Ratings (@ TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 6)		VRRM VRWM VR	600	٧
RMS Reverse Voltage		VR(RMS)	417	V
Average Rectified Output Current	@ T _C = +130°C	lo	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		IFSM	100	Α
Single Pulse Avalanche Energy L = 15mH		Eas	10.8	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Air (Note 5)	$R_{\theta JA}$	47	°C/W
Typical Thermal Resistance, Junction to Case (Note 5)	Rejc	12	°C/W
Typical Thermal Resistance, Junction to Lead (Note 5)	R ₀ JL	26	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	600	_	_	V	I _R = 5µA
Forward Voltage	VF	_	1.02	1.25	V	I _F = 3A, T _A = +25°C
Leakage Current (Note 6)	I _R		0.1 35	5 150	μΑ	V _R = 600V, T _A = +25°C V _R = 600V, T _A = +150°C
Reverse Recovery Time	t _{RR}	_	_	50	ns	IF = 0.5A, I _R = 1.0A, I _{RR} = 0.25A
Total Capacitance	Ст	_	45	_	pF	V _R = 4V, f = 1.0MHz

Notes:

- 5. Unit mounted on glass epoxy substrate 1oz/ft 12mm x 12mm copper pad.6. Short duration pulse test used to minimize self-heating effect.



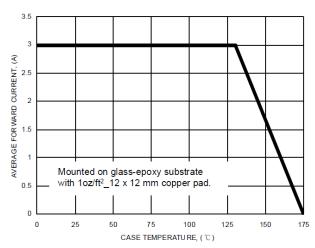


Figure 1. Forward Current Derating

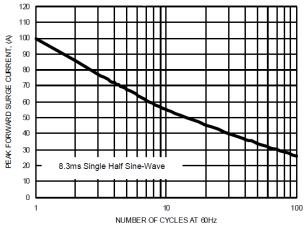


Figure 3. Maximum Non-Repetitive Surge Current

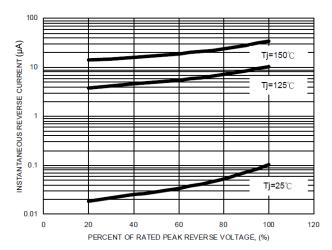


Figure 5. Typical Reverse Characteristics

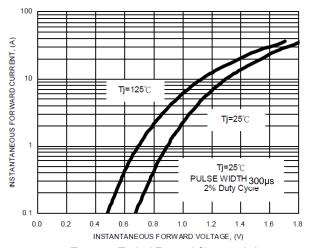


Figure 2. Typical Forward Characteristic

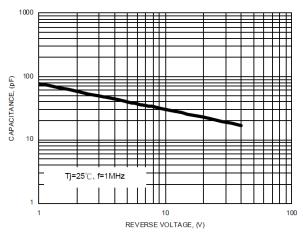


Figure 4. Typical Total Capacitance



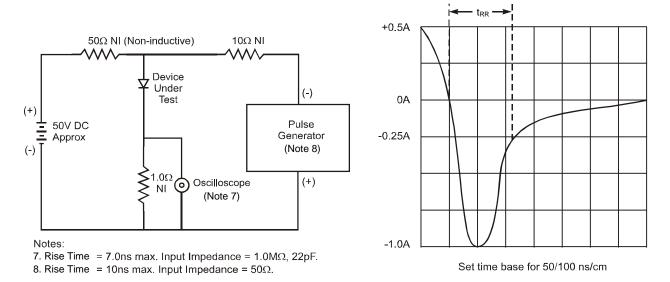


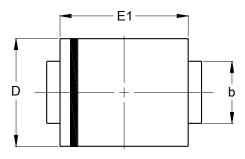
Figure 6. Reverse Recovery Time Characteristic and Test Circuit

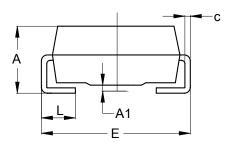


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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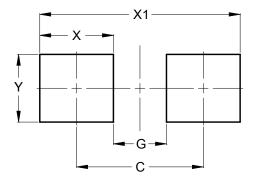


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Dim	Min	Max			
Α	2.00	2.50			
A1	0.05	0.20			
b	1.96	2.21			
C	0.15	0.31			
D	3.30	3.94			
Е	5.00	5.59			
E1	4.06	4.57			
L	0.76	1.52			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMB



Dimensions	Value (in mm)		
С	4.30		
G	1.80		
Х	2.50		
X1	6.80		
Υ	2.30		



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